

Features

- 3210 2.1mm SMD LED
- High Brightness
- AllnGaP / InGaN Technology
- Small package
- High reliability
- Clear Lens

Applications

- Consumer Electronics
- Wearables
- Automobile After Market
- Industrial Equipment

Description

The IN-S121DBSRYG is a dual-color 3210 package with versatile design capabilities. It is a PCB type molding style LED which can be used in various applications.

Recommended Solder Pattern

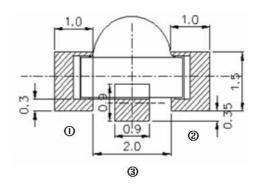
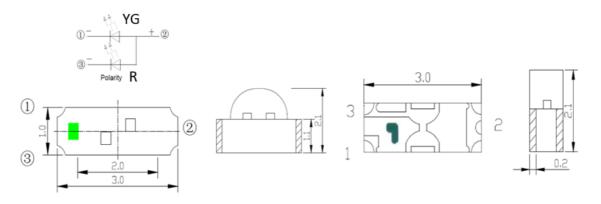


Figure 1. IN-S121DBSRYG Solder Pattern

Package Dimensions in mm



Notes.

- 1. All dimensions are in millimeters.
- 2. Tolerance is ± 0.1 mm unless otherwise noted





Absolute Maximum Rating at 25°C (Note 1)

Product	Emission Color	P _d (mW)	I _F (mA)	I _{FP} * (mA)	V _R (V)	T _{OP} (°C)	T _{ST} (°C)	
	Red			70				
IN-S121DBSRYG	Yellow Green	75	25	70	5	-30ºC~+85ºC	-40ºC~+90ºC	

Notes

1. Condition for IFP is pulse of 1/10 duty and 0.1msec width

ESD Precaution

ATTENTION: Electrostatic Discharge (ESD) protection



The symbol above denotes that ESD precaution is needed. ESD protection for GaP and AlGaAs based chips is necessary even though they are relatively safe in the presence of low static-electric discharge. Parts built with AlInGaP, GaN, or/and InGaN based chips are STATIC SENSITIVE devices. ESD precaution must be taken during design and assembly.

If manual work or processing is needed, please ensure the device is adequately protected from ESD during the process.

Please be advised that normal static precautions should be taken in the handling and assembly of this device to prevent damage or degradation which may be induced by electrostatic discharge (ESD).

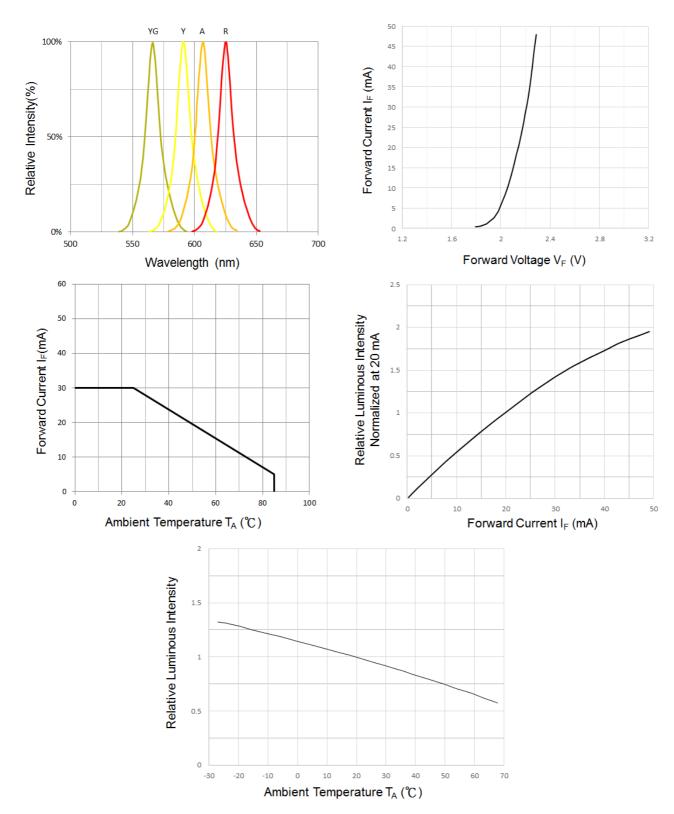
Electrical Characteristics $T_A = 25$ °C (Note 1)

	Emission		V _F (V)			λ(nm)	Viewing Angel	l* _v (mcd)	
Product	Color	l _⊧ (mA)	typ.	max	λ_{D}	λ_{P}	$ riangle \lambda$	2 0 1/2	typ.
	Red	20	2.2	2.6	622	630	20	130	110
IN-S121DBSRYG	Yellow Green	20	2.2	2.6	573	576	15	130	30

Notes

1. Performance guaranteed only under conditions listed in above tables.

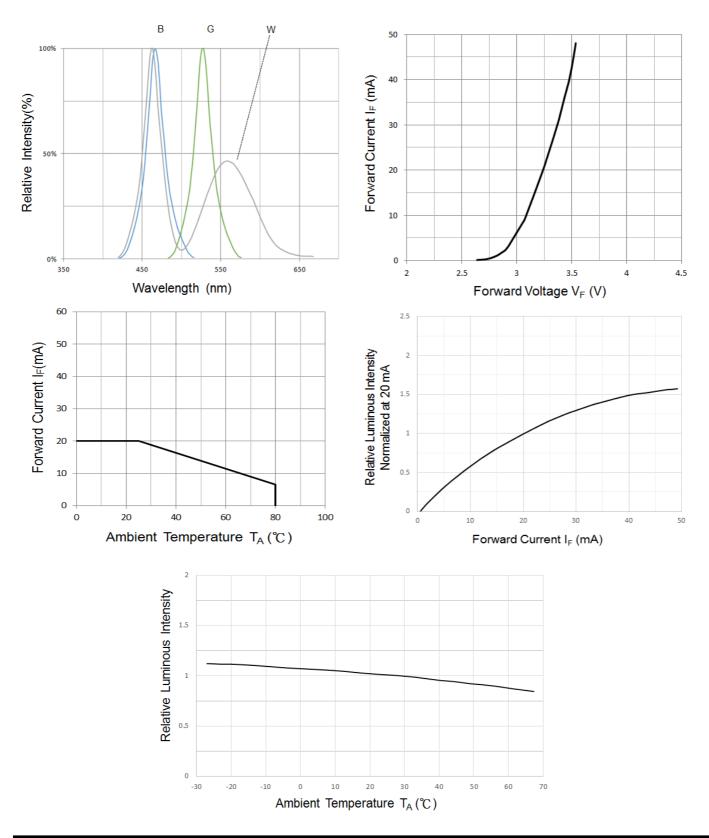




Typical Characteristic Curves – YG, Y, A, R

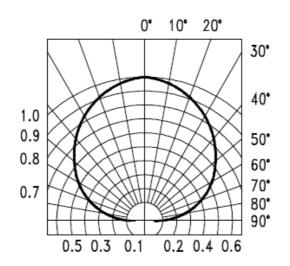


Typical Characteristic Curves – B, G, W





Typical Characteristic Curves – Radiation Pattern

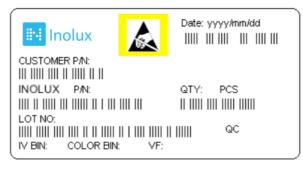


Ordering Information

Product	Emission Color	Test Current I _F (mA)	Luminous Intensity Iv (mcd) (Typ.)	Forward Voltage V _F (V) (Typ.)	Orderable Part Number
	Red	20	110	2.2	
IN-S121DBSRYG	Yellow Green	20	30	2.2	IN-S121DBSRYG



Label Specifications



Inolux P/N:

	Ν	-	S	1	2	1	D	В	S			R	YG		-	x x	x x	(
			Material	Р	ackag	ge	Varia	ation	Orientation	Current	Lens	Co	lor	Chip Type			mized np-off	
nolı SMI			S = PCB Type	121	.DB = 1	3.0 x :	1.0 x 2.	1mm	S= Side Mount	(Blank) = 20mA	(Blank) = Clear		30nm 76nm	(blank) = Standard				

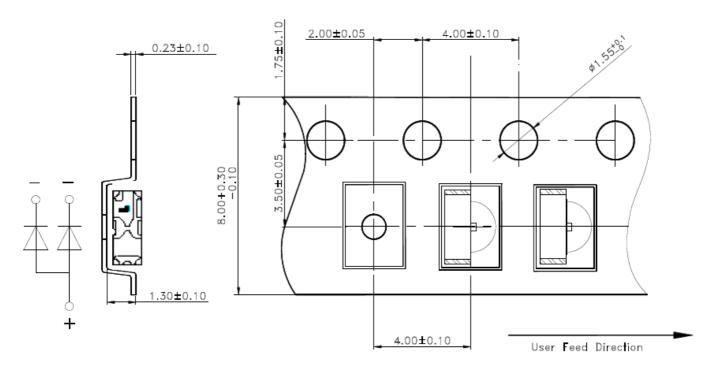
Lot No.:

Z	2	0	1	7	01	24	001
Internal		Year (2017	2018)	Month	Date	Serial	
Tracker			, 2010,)	Wonth	Date	Schar	

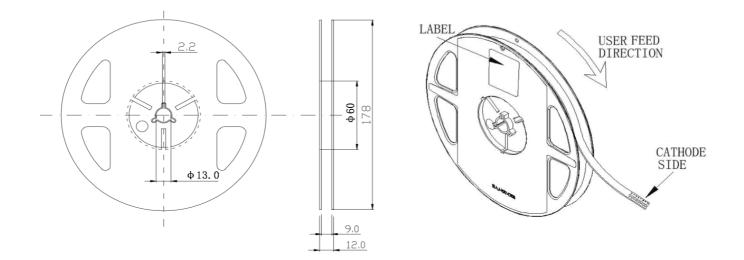


Packaging Information: 2000pcs Per Reel

Tape Dimension

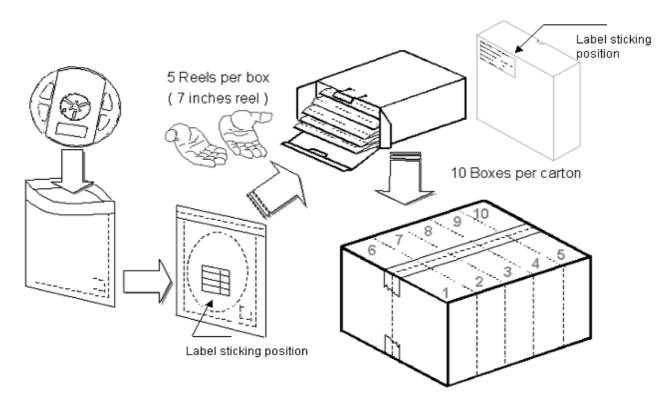


Reel Dimension





Packing Dimension



5 boxes per carton are available depending on shipment quantity.

Specification	Material	Quantity
Per EIA 481-1A specs	Conductive black tape	2000pcs per reel
Per EIA 481-1A specs	Conductive black	
IN standard	Paper	
220x240mm	Aluminum laminated bag/ no-zipper	One reel per bag
IN standard	Paper	Non-specified
-	Per EIA 481-1A specs Per EIA 481-1A specs IN standard 220x240mm	Per EIA 481-1A specsConductive black tapePer EIA 481-1A specsConductive blackIN standardPaper220x240mmAluminum laminated bag/ no-zipper

Others:

Each immediate box consists of 5 reels. The 5 reels may not necessarily have the same lot number or the same bin combinations of Iv, λ_D and Vf. Each reel has a label identifying its specification; the immediate box consists of a product label as well.

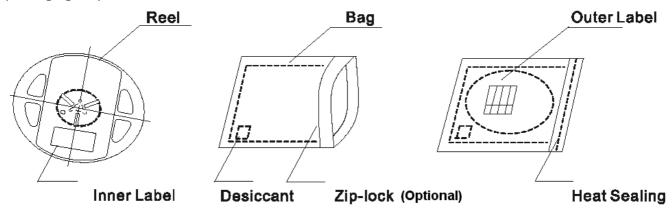


Dry Pack

All SMD optical devices are **MOISTURE SENSITIVE**. Avoid exposure to moisture at all times during transportation or storage. Every reel is packaged in a moisture protected anti-static bag. Each bag is properly sealed prior to shipment.

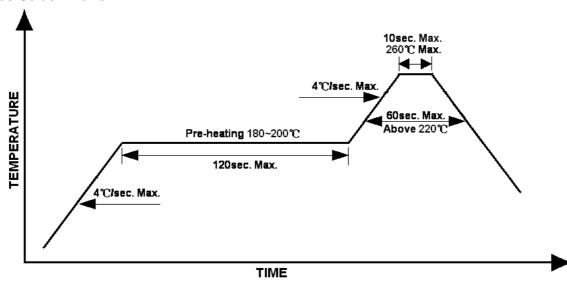
Upon request, a humidity indicator will be included in the moisture protected anti-static bag prior to shipment.

The packaging sequence is as follows:



Reflow Soldering

- Recommended tin glue specifications: melting temperature in the range of 178~192 °C
- The recommended reflow soldering profile is as follows (temperatures indicated are as measured on the surface of the LED resin):



Lead-free Solder Profile



Precautions

- Avoid exposure to moisture at all times during transportation or storage.
- Anti-Static precaution must be taken when handling GaN, InGaN, and AlInGaP products.
- It is suggested to connect the unit with a current limiting resistor of the proper size. Avoid applying a reverse voltage.
- Avoid operation beyond the limits as specified by the absolute maximum ratings.
- Avoid direct contact with the surface through which the LED emits light.
- If possible, assemble the unit in a clean room or dust-free environment.

Reworking

- Rework should be completed within 5 seconds under 260 °C.
- The iron tip must not come in contact with the copper foil.
- Twin-head type is preferred.

Cleaning

Following are cleaning procedures after soldering:

- An alcohol-based solvent such as isopropyl alcohol (IPA) is recommended.
- Temperature x Time should be 50°C x 30sec. or <30°C x 3min
- Ultra sonic cleaning: < 15W/ bath; bath volume ≤ 1liter
- Curing: 100 °C max, <3min

Cautions of Pick and Place

- Avoid stress on the resin at elevated temperature.
- Avoid rubbing or scraping the resin by any object.
- Electro-static may cause damage to the component. Please ensure that the equipment is properly grounded. Use of an ionizer fan is recommended.



Revision History

Changes since last revision	Page	Version No.	Revision Date
Initial Release		V1.0	05-12-2017
Updated	1	V1.1	04-03-2024

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